



Advances in Communication Technology with Artificial Intelligence

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Message from the Guest Editor

Dear Colleagues,

The combination of communication technology and artificial intelligence can change the view of our thinking aspects and revolutionize our lifestyle. Artificial intelligence (AI) is an integral part of communication technologies such as 5G 6G, and 7G, and it is poised to fundamentally shift the Information and Communications Technology (ICT) industry with technologies such as machine learning, natural language processing, and deep learning, which will dramatically enhance the performance of communications, apps, content, and digital commerce. AI will also drive new business models and create entirely new business opportunities as interfaces and efficiencies facilitate engagement that has been heretofore impossible.

The goal of this Special Issue is to provide a platform for researchers/designers and academicians to share their up-to-date works and to identify issues and challenges for further research into the emerging communication technology with artificial intelligence.





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Message from the Editor-in-Chief

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